## Indemnity bond on the Non Judicial paper of Rs. 500/- to be notarized and submitted in college.

## **INDEMNITY BOND**

I, Mr./Msaged about years
at present residing at
(current address) my permanent address is
do hereby state on solemn affirmation on this day of(month) 2022, as
under:-
1. I was admitted in First year / Direct Second year inbranch of
Engineering through CAP round at Pillai College of Engineering, New Panvel
in the Academic year 20 I was studying in First year / Second year /
Third year / Final Year of Engineering in the Academic Year 2021-22. As I
was eligible for the scholarship, I had filled up the application along with all
the necessary documents on MahaDBT portal under the scheme named as Post
matric Scholarship / Freeship applicable to SC category students for the
reimbursement of fees during the AY 2021-22. The said application is
scrutinized by the concerned authorities and approved / under approval process
on MahaDBT portal.

- 2. According to the Central Government guidelines, 60% of the SC Scholarship / freeship amount will be credited to my Savings Bank account mentioned in the Scholarship / free ship application form.
- 3. The 60% of the eligible SC Scholarship / freeship amount receivable from the Central Government to be deposited in my savings bank account is to be refunded to the College by me.
- 4. In view of the Central Government Guidelines, I abide to transfer the 60% of the SC Scholarship / freeship amount received from the Government in my bank account to the College within 7 days from the receipt of such amount in my bank account.
- 5. Since I am not aware about when the 60% SC scholarship / Freeship amount transferred by the Government in my bank account, whenever I get the

Scholarship / freeship amount, I will pay the said amount to the College within 7 days from the receipt of such amount in my bank account. If I fail to do so, the College is at liberty to initiate legal action against me for the recovery of the amount and I will be solely liable for the consequences and effects arising due to non-payment.

- 6. I indemnify Pillai College of Engineering, New Panvel from any type of loss or damage caused to the College in legal proceedings due to my indemnity bond given herein above regarding the payment of the Scholarship / freeship amount to the College.
- 7. I shall communicate to the College about change of my present address, mobile number and email ID, if any from time to time.

I hereby declare that the above information given by me is true to the best of my knowledge and belief.

Date:	
Place:	
	Signature of the student
	Name of the student
	Department :Engineering
Witness:	
1. Mr./Ms	
	Sign
2. Mr./Ms	
	Sign